

TOP Nanometal Corp Offers Customized FCCL Solutions for Small and Medium-sized FPC and IC Substrate Manufacturers

NEW TAIPEI CITY, TAIWAN, December 22, 2020 /EINPresswire.com/ -- TOP [Nanometal](#) Corporation is a professional electronic materials manufacturer specializing in 2-layer FCCL, mainly used for flexible printed circuit boards. It also assists small and

medium-scale [FPC](#) manufacturers and electronic factories to develop and design new products with its innovative FCCL solutions. TOP Nanometal Corporation will be showcasing its new product, Ultra Thin [2L-FCCL](#) (2-Layer Flexible Copper Clad Laminate) at a number of upcoming industry exhibitions including Touch Taiwan 2021, a leading exhibition for the display and high-tech industries during Apr 21 - Apr 23, 2021.

“

TOP Nanometal Corporation's R&D and engineering team has more than 30 years' experiences in R2R sputtering, chemical electroplating/electroforming process developing, and machine design.”

CEO of TOP Nanometal Corporation



昂筠國際股份有限公司
TOP Nanometal Corporation

The Ultra Thin 2L-FCCL is the thinnest FPC type of FCCL, which is the preferred FPC material for fine pitch, narrow border pattern design, especially for 5G applications. TOP Nanometal Corporation is committed to providing high quality and value-added electronic materials to customers worldwide, and sees vast opportunities in customized products with strong technical expertise. TOP Nanometal Corporation will continue supporting and providing FCCL solutions to customers with latest and exceptional ideas

and designs.

Top Competitive Advantages:

- Provide 2um~8um Ultra thin 2L-FCCL for flexible PCB design
- High heat resistance
- Fine flexural/bending endurance

“TOP Nanometal Corporation's R&D and engineering team has more than 30 years' experiences in R2R sputtering, chemical electroplating/electroforming process developing, and machine

design. We are capable of systematically expanding capacity, ensuring highly stable process, and consistently developing next generation products for our customers.” – CEO of TOP Nanometal Corporation

About TOP Nanometal Corporation
Founded in 2015 and headquartered in New Taipei City, Taiwan, TOP Nanometal Corporation is an advanced leader in developing and providing innovative electronic materials for the PCB industry. TOP Nanometal Corporation's Ultra thin 2L-FCCL can not only be used for FPC, but also can be applied in fine pitch IC Substrate as ultra thin copper foil (developing project). Our customer base includes world renowned FPC manufacturers and SME design houses.

For more information, please visit
<http://topnano.com.tw/en-index.php>.

Additional Information:

Press Kit download:

<https://brand.sparkamplify.com/top-nanometal-corporation>

###

Media contact: Shirley Lin

Email: shirley.lin@topnano.com.tw

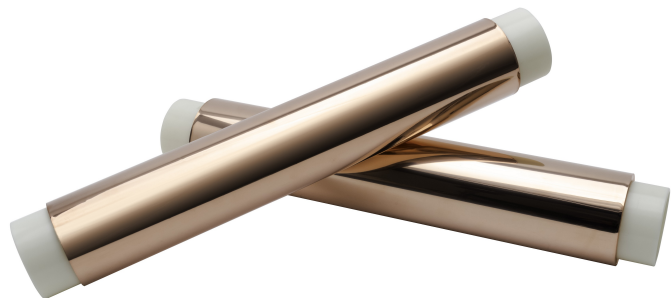
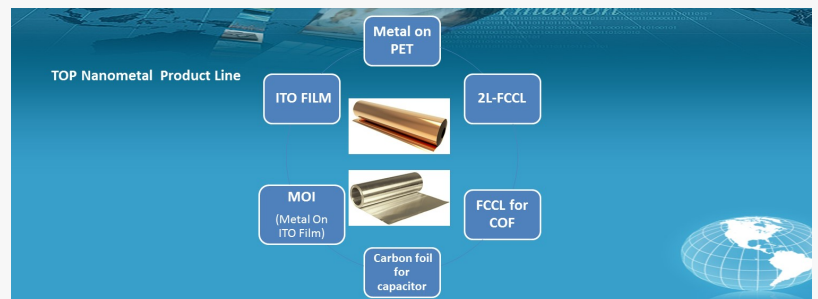
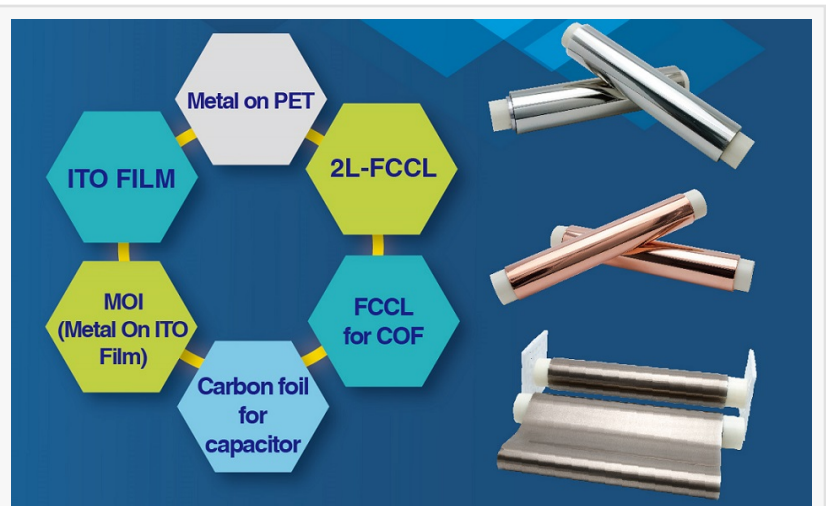
Phone: +886-2-2298-3539 ext.8896

Website: <http://topnano.com.tw/en-index.php>

Shirley Lin

TOP Nanometal Corporation

[email us here](#)



This press release can be viewed online at: <https://www.einpresswire.com/article/533299272>

EIN Presswire's priority is source transparency. We do not allow opaque clients, and our editors try to be careful about weeding out false and misleading content. As a user, if you see something we have missed, please do bring it to our attention. Your help is welcome. EIN Presswire, Everyone's Internet News Presswire™, tries to define some of the boundaries that are reasonable in today's world. Please see our Editorial Guidelines for more information.

© 1995-2020 IPD Group, Inc. All Right Reserved.